



Emerging Topics in Wireless Security and Privacy towards 6G Networks

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Deadline for manuscript
submissions:

15 October 2024

Message from the Guest Editors

The International Telecommunication Union (ITU) has suggested that the Sixth Generation (6G) wireless networks will realize pervasive, intelligent, efficient connections among humans, machines and things, bridge the physical and virtual worlds, and integrate the sensing and artificial intelligence (AI) as new typical scenarios. These upcoming changes will introduce new security challenges. Meanwhile, the users and applications of 6G will shift towards a smart industry, digital healthcare, digital twin and extended world, etc., which leads data transmission, storage and utilization to become much more vulnerable to privacy leaks and illegal usages. Since security, privacy and resiliency are emphasized as the key integrated capabilities of the 6G network, it is crucial to develop new security and privacy techniques to incorporate in the design of 6G networks. In this regard, the objective of this Special Issue is to develop ground-breaking techniques to provide security and privacy for 6G wireless communications. Original research articles and reviews are welcome.





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Message from the Editor-in-Chief

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